# Deep Diffused APDs for Charged Particle Timing Applications: Performance after Neutron Irradiation

M. Centis Vignali<sup>1</sup>, M. Gallinaro<sup>1,2</sup>, B. Harrop<sup>3</sup>, C. Lu<sup>3</sup>, M. McClish<sup>4</sup>, K. T. McDonald<sup>3</sup>, M. Moll<sup>1</sup>, F. M. Newcomer<sup>5</sup>, S. Otero Ugobono<sup>1,6</sup>, and S. White<sup>1,7</sup>

<sup>1</sup>CERN, Geneva, Switzerland

<sup>2</sup>LIP, Lisbon, Portugal

<sup>3</sup>Princeton University, Princeton, USA

<sup>4</sup>Radiation Monitoring Devices, Watertown, USA

<sup>5</sup>University of Pennsylvania, Philadelphia, USA

<sup>6</sup>Universidade de Santiago de Compostela, Santiago de Compostela, Spain

<sup>7</sup>University of Virginia, Charlottesville, USA

December 14, 2018

#### Abstract

The high luminosity upgrade of the CERN Large Hadron Collider (HL-LHC) will result in a pile-up of around 200 proton-proton collisions per bunch crossing. In order to reduce the impact of pile-up on physics analyses the ATLAS and CMS experiments are planning to use the timing of physics objects within one event. The primary proton-proton collisions have an RMS spread of  $\approx$ 170 ps within one bunch crossing, and a time resolution of around 30 ps is require for pile-up mitigation. This performance requires dedicated detectors for the timing of minimum ionising particles. The timing detectors will be subjected, for the goal integrated luminosity of 3000 fb<sup>-1</sup>, to radiation levels corresponding to a 1-MeV neutrons fluence ( $\Phi_{eq}$ ) of about  $10^{14}$  or  $10^{15}$  cm<sup>-2</sup> for the barrel and end-cap regions, respectively.

In this paper, deep diffused Avalanche Photo Diodes (APDs) produced by Radiation Monitoring Devices are examined as candidate timing detectors for HL-LHC applications. To improve the detector's timing performance, the APDs are used to directly detect the traversing particles, without a radiator medium where light is produced. These APDs are operated at  $1.8\,\mathrm{kV}$ , resulting in a gain of up to 500. The detectors have an active area of up to  $8\times8~\mathrm{mm}^2$ , close to the channel size of the CMS barrel timing layer.

Devices with an active area of  $8 \times 8 \,\mathrm{mm}^2$  were characterised using a pulsed infrared laser and, in some cases, an high energy muon beam. The timing performance as well as the uniformity of response are examined in this paper.

The effects of radiation damage on current, signal amplitude, noise, and timing of the APDs are evaluated using detectors with an active area of  $2 \times 2 \,\mathrm{mm}^2$ . These detectors were irradiated with neutrons up to  $\Phi_{eq} = 10^{15} \,\mathrm{cm}^{-2}$ . Their timing performance was characterised using a pulsed infrared laser.

### Contents

1	Introduction	2
2	Deep Diffused APDs	3
3	Samples and Irradiations 3.1 $2 \times 2 \text{ mm}^2 \text{ APDs}$	4 4 5
4	Gain Measurement of $8 \times 8 \text{ mm}^2$ APDs using a Blue LED	5
5		5 5 7
6	Uniformity Study of $8 \times 8 \text{ mm}^2$ APDs using an Infrared Laser	13
7	Timing Performance of $8 \times 8 \text{ mm}^2$ APDs using an Infrared Laser	15
8	Beam Tests of $8 \times 8 \text{ mm}^2$ APDs with AC-coupled Readout	16
9	Summary	18

#### 1 Introduction

The high luminosity upgrade of the CERN Large Hadron Collider (HL-LHC) foreseen to start in 2026 will provide an instantaneous luminosity of up to  $5 \cdot 10^{34} \, \mathrm{cm^{-2} s^{-1}}$  with a bunch spacing of 25 ns, and an average pile-up of up to 200 collisions per bunch crossing [1]. This value of pile-up presents a challenge for the experiments, as currently ATLAS and CMS have reached a typical pile-up of  $\approx 30 \, \mathrm{ref?}$ . At the present, the effects of pile-up on physics analyses are mitigated by resolving the primary vetexes within one bunch crossing along the beam axis. The physics objects are then associated to the primary vertexes. This strategy was used also at Tevatron, where the pile-up was 6 ref?. The pile-up at HL-LHC will pose a challenge to this method, as a significant fraction of the primary vertexes will have a distance smaller than the resolution of the vertex detectors, making an association to the physics objects impossible.

A different method to reconstruct the primary vertexes relies on the measurement of the time of creation of the particles traversing the detectors. A sufficiently accurate time measurement effectively reduces the vertex density, improving the vertex reconstruction capability of the experiments. Since the RMS spread of the primary vertexes at HL-LHC is foreseen to be  $\approx 170$  ps within one bunch crossing, a minimum ionising particle (MIP) time resolution of  $\approx 30$  ps is necessary for a correct association of the particles to their primary vertexesref?

To reach this performance, dedicated detector systems will be needed and both ATLAS and CMS are planning such upgrades [2, 3].

By exploiting the design margins of HL-LHC, it will be possible to achieve an ultimate luminosity of up to  $7.5 \cdot 10^{34} \, \mathrm{cm}^{-2} \mathrm{s}^{-1}$  and an ultimate integrated luminosity of  $4000 \, \mathrm{fb}^{-1}$  [1]. In this scenario the pile-up and fluence to which the detectors will be exposed will increase proportionally to the instantaneous and integrated luminosity, respectively.

All the proposed technologies for ATLAS and CMS timing layers involve silicon with snternal gain: Silicon Photomultipliers (SiPMs) or Low Gain Avalanche Diodes (LGADs) [2, 3]. In this context, avalanche silicon diode structures with a capacitively coupled readout for charged particle timing were evaluated. The characteristics of these detectors make them suitable for applications where a pixel size of order of 1 cm<sup>2</sup> is appropriate.

This paper summarizes the characterization of deep diffused Avalanche Photo Diodes (APDs) produced by Radiation Monitoring Devices [4] used as timing detectors for charged particles. Studies of these sensors as Minimum Ionising Particle (MIP) timing detectors, using an AC-coupled readout, were performed previously and showed promising results [5]. The timing performance as well as the radiation hardness of these devices are addressed. Section 2 provides a general description of the deep diffused APDs. In section 3 a detailed description of the devices used in this study is given. Section 4 contains the measurement of the gain for blue light of APDs with an active area of  $8 \times 8 \text{ mm}^2$ . Both the bias and temperature dependence of the gain are explored. Section 5 reports the characterisation of neutron-irradiated APDs with an active area of  $2 \times 2 \text{ mm}^2$ . Sections 6 and 7 respectively summarise uniformity and timing measurements of APDs with an active area of  $8 \times 8 \text{ mm}^2$  with DC-coupled and AC coupled readout. Section 8 describes the methods and results obtained though beam tests of APDs with an active area of  $8 \times 8 \text{ mm}^2$  with AC-coupled readout. Finally, section 9 summarises the results obtained in this study.

## 2 Deep Diffused APDs

Deep diffused APDs consist of a pn-junction operated in reverse bias. Bias voltage is applied to the detector in order to achieve an electric field high enough for the charge carriers to undergo impact ionization. This mechanism is responsible for the multiplication of the charge carriers released by the passage of a charged particle or light impinging on the detector.

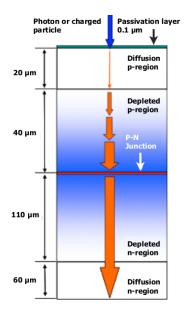
The pn-junction is located several tens of microns from the detector surface. This, together with the shape of the doping profile, prevents the depletion region from reaching the detector's surface, avoiding breakdown and noise due to surface effects. The concept of full depletion voltage, usually applied to detectors produced through the planar process, is not used with this type of APD.

The occurrence of breakdown and noise from the edges of the detector die is mitigated by reducing the electric field in these regions. This can be achieved by beveling the detector's edges [6]. The current APD design reduces the electric field at the edges of the depletion region by distributing the doping in the sensor such that the depletion region is "bent" and terminated on one of the sensor's surfaces [6]. A mesa structure reduces the electric field at the sensor's surface.

Deep diffused APDs get their name from the process used to produce a pn-junction several tens of microns from the detector surface. The APDs used in this work are produced on silicon using the method explained in [6, 7]. Grooves are carved on both sides of an n-doped silicon wafer and p-type dopants are diffused into the silicon. The grooves run parallel to the future die edges and shape the distribution of the p-type dopants into the silicon. This process results in an n-doped region enclosed by the p-doped silicon. The wafer is ground and polished on both sides. One side is ground more than the other in order to reach the n-doped region. At this point, the n-doped region is exposed on one side and surrounded by p-type silicon. The pn-junction runs parallel to the detector surface and curves toward the side with the exposed n-doped region. Non-metallic conductive layers are added on both sides to provide ohmic contacts to the p and n-doped volumes. A mesa structure is then etched following the pn-junction on the side where the n-doped region is exposed. Finally, polyimide is deposited around the mesa structure and the wafer is diced.

Schematic cross-sections of the centre and the edge of the resulting device are shown in figure 1. In the following, the faces of the detectors will be referred to as p- and n-side, according to the sketch shown in figure 1.

The doping concentration of the n-type silicon is constant over the thickness of the detector, since it results from the initial doping of the silicon wafer. The p-type silicon has a different doping profile. As the p-type dopants are introduced through diffusion, the doping concentration of the p-type silicon is higher toward the p-side of the detector and falls toward the pn-junction. This results in a broader peak of the electric field at the pn-junction, when compared to the triangular shape of an abrupt junction. The broadening of the peak increases the distance over which the charge carriers drift in the highest field region, requiring a lower peak field for a given gain value. This reduces the ratio between the electron and hole multiplication coefficients, reducing in turn



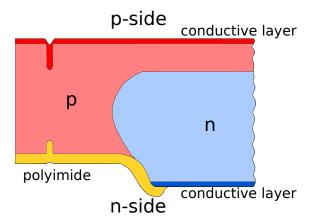


Figure 1: Schematic cross-sections of a deep diffused APD. **Left:** centre of the detector. The thickness of the depleted region corresponds to a bias voltage of 1.8 kV. **Right:** detector edge.

the excess noise factor due to multiplication [8].

The applied bias voltage is usually around 1.8 kV, resulting in a gain of up to 500. At this bias voltage the thickness of the depletion region is around 150  $\mu$ m.

## 3 Samples and Irradiations

All the APDs used in this study present the structure detailed in the previous section. Detectors of two different sizes were used. In this section, the geometry and readout of the different APDs are explained.

## 3.1 $2 \times 2 \text{ mm}^2 \text{ APDs}$

APDs with a nominal active area of  $2 \times 2$  mm<sup>2</sup> were used to study the effects of neutron irradiation. The dies of these devices have an area of  $3.1 \times 3.1$  mm<sup>2</sup> and a circular mesa structure with a diameter of about 0.8 mm. These devices are mounted on ceramic supports, two metallic leads are used to contact the p- and n-sides of the detector. The n-side of the detector faces the ceramic support. The contact between the APD and the metal leads is achieved using conductive glue.

The  $2 \times 2 \text{ mm}^2$  APDs have a DC-coupled readout. In order to facilitate the handling and electrical connection to the sensors, each APD was mounted on a printed circuit board (PCB) for its characterisation both before and after irradiation. The PCB was equipped with a temperature sensor and the connectors needed to link the APD to the measuring devices.

The sensors were irradiated with neutrons at the nuclear reactor of the Jožef Stefan Institute in Ljubljana [9]. The fluences accumulated by the sensors ranged from  $\Phi_{eq} = 3 \cdot 10^{13} \, \mathrm{cm}^{-2}$  to  $\Phi_{eq} = 10^{15} \, \mathrm{cm}^{-2}$ . Neither bias nor cooling were applied during the irradiation, the temperature of the samples is estimated to range between 20 and 45°C during irradiation [10]. After irradiation, the samples were stored at a temperature below  $-18^{\circ}$ C to avoid the annealing of the defects produced during irradiation. No annealing steps were performed after irradiation, however, it is estimated that the annealing due to handling after irradiation corresponds roughly to one hour at room temperature.

## 3.2 $8 \times 8 \text{ mm}^2 \text{ APDs}$

APDs with a nominal active area of  $8 \times 8 \text{ mm}^2$  were characterised in several beam tests. The dies of these devices have an area of  $10 \times 10 \text{ mm}^2$  and a square mesa structure with 7.5 mm sides.

As shown in section 6, the amplitude of the signal produced by the sensor when illuminated by a laser depends on the distance between the point in which the sensor is struck by the laser and the point where the sensor is connected to the readout electronics. This behaviour is the result of the non-negligible resistance of the conducting layers applied to the p- and n-side of the detector.

Two methods were used to improve the uniformity of response. The first one relies on an AC-coupled readout of the p-side of the detector. A gold layer is applied to the n-side of the detector to improve its conductivity. The electrical contact to the p-side is achieved through the formation of a bond-pad and wire-bonding. The p-side is covered by a Kapton layer and a metallic mesh is placed above the Kapton. The mesh picks-up the signal and provides an electrical path with a resistivity lower than the one of the conductive layer. The sensors produced with this configuration were usually placed on PCBs containing the readout electronics. These detectors are usually operated by applying the high voltage to the p-side and keeping the n-side at ground potential. In this way it is possible for the electronics to directly read out both signals from the mesh and the n-side of the sensor.

Another method used to improve the uniformity of response is the metallisation of both the p- and n-side of the detector. The metallisation consists in an aluminium deposition containing openings for laser illumination. The detectors produced with this configuration have a DC-coupled readout and were used in laboratory tests. These sensors were mounted on the same kind of PCBs used for the  $2 \times 2$  mm<sup>2</sup> APDs, that contain a temperature sensor and the connectors to bias and readout the sensor.

In this paper detectors with both the DC-coupled mesh readout are characterised, but at the time of this writing only DC-coupled devices have been characterized after irradiation.

# 4 Gain Measurement of $8 \times 8 \text{ mm}^2$ APDs using a Blue LED

The gain of  $8 \times 8 \text{ mm}^2$  APDs was measured using a pulsed LED. The LED had a wavelength of 425 nm and the pulses had a duration of 20 ns. Readout? Unity gain refers to the amplitude obtained at  $\approx 500 \text{ V}$  bias, where the amplitude shows a weak dependence on the bias voltage V. The measurements were performed at different temperatures, and the results are reported in figure??. An attempt was made to parametrize regular trend in V required for a given gain as a function of temperature T. A temperature dependent shift  $V' = V - 2.45 \cdot T(0C')$  describes the change in voltage necessary to obtain a given value of gain when the APD temperature changes. What does the (0C) mean in this case? Does the shift refer to the 0C curve? This parametrization of the pattern up to a gain of  $\approx 1000 \text{ may}$  prove useful for discriminating among impact ionization models that appear in the literature and as options in  $TCAD^1$  software for modeling such devices. It should be noted that this particular definition of gain, as it applies to visible light photodetection in an APD, will likely differ from the response to minimum ionizing particles (or the IR laser model used) since, in the former case all photoelectrons traverse the region where impact ionization occurs. Another difference could be the focusing? Was the light focussed? Which was the intensity?

## 5 Laboratory Characterisation of Irradiated $2\times2$ mm<sup>2</sup> APDs

#### 5.1 Experimental Methods

Two experimental setups were used to characterise the APDs.

The current-voltage characteristic of the detectors was measured using a voltage source and a picoammeter connected in series to the sensor under test. The sensor was placed inside a climate

<sup>&</sup>lt;sup>1</sup>Technology Computer Aided Design.

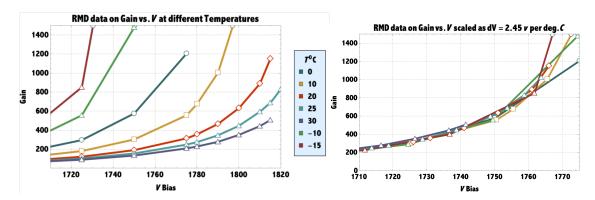


Figure 2: **Left:** Gain of a  $8 \times 8 \text{ mm}^2$  APDs as a function of bias voltage at different temperatures. The measurement was performed using a blue LED. **Right:** By shifting the bias for each curve according to the law described in the text, a scaling law is found.

chamber flushed with dry air where the temperature could be controlled. The temperature sensor on the PCB was used to ensure that the APD reached thermal equilibrium with the air in the climate chamber before starting the measurements.

The response of the APDs to a pulsed infrared laser was measured in a different setup and used to determine the variation of the sensor's signal and time resolution as a function of bias voltage and irradiation fluence. The laser has a wavelength of 1064 nm and the pulses have a duration of 200 ps. The repetition rate was chosen to be 200 Hz. The intensity of the light impinging on the APD was determined to correspond to a charge deposition in the sensor of 15 or 0.8 MIPs per pulse, depending on the measurement. A shutter is used to change the light intensity. The amount of deposited charge per laser pulse was measured using a non-irradiated pad diode of known thickness. The charge deposited for one MIP is defined as 74 electron hole pairs per micron of silicon. The wavelength used has an absorption length in silicon of about 1 mm, resulting in the generation of electron hole pairs through the whole sensor thickness. The light pulses are propagated from the laser to the sensor through an optical fibre. A coupler diverts part of the light to a photodiode that is used to monitor the intensity of the light pulses. An optical system focuses the light on the sensor surface producing a beam spot of about 15  $\mu$ m in diameter. The bias voltage of the sensor under test is provided by a voltage source containing a picoammeter used to monitor the current flowing through the sensor. The temperature of the APD was controlled using a cooling system constituted by a Peltier element and a chiller. The temperature measured by the temperature sensor on the PCB was used as input to the Peltier control system. The APD was housed in a light-tight Faraday cage flushed with dry air during the measurements. The APD signal was amplified using a CIVIDEC C2HV broadband amplifier [11]. Both the signals of the APD and the photodiode were digitised using an oscilloscope with 2.5 GHz bandwidth and a sampling rate of 20 GSa/s.

For the measurement of the APD signal amplitude and uniformity of response, an amplification of  $10\,\mathrm{dB}$  was used, together with a light intensity corresponding to  $15\,\mathrm{MIPs}$ . This amplification was achieved by attenuating the APD signal with a  $30\,\mathrm{dB}$  attenuator and then amplifying it with a  $40\,\mathrm{dB}$  amplifier. The  $40\,\mathrm{dB}$  amplifier is the same used in the time resolution measurements. The reduction of the gain to  $10\,\mathrm{dB}$  is necessary in order to perform the amplitude measurements over the desired bias voltage range while remaining in the amplifier's linear range. For each measurement condition, the waveforms were averaged  $256\,\mathrm{times}$  in the oscilloscope before being stored for analysis.

The time resolution measurements were performed applying a  $40\,\mathrm{dB}$  amplification to the APD signal. No averaging was applied to the waveforms. A gain of  $40\,\mathrm{dB}$  provides a better signal to noise ratio for the APD signal, compared to the  $10\,\mathrm{dB}$  used for the amplitude measurement. The intensity of the light shone on the APDs for these measurements corresponded to  $0.8\,\mathrm{MIPs}$ . The optical system was modified for the timing measurements. A splitter and delay line system was

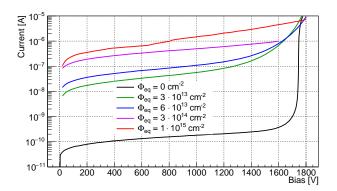


Figure 3: Current-voltage characteristics of the  $2 \times 2 \text{ mm}^2$  APDs measured at  $-20^{\circ}\text{C}$  for different neutron fluences.

introduced, allowing to shine two light pulses on the sensor for each pulse generated by the laser. The system is realised using optical fibre, and consisted of a splitter, a short and a long optical fibre branch, and a merger. The difference in length between the two branches corresponds to a delay of 50 ns between the pulses. The sensor's signals from the light pulses were digitised in the same waveform in the oscilloscope. The difference in the amplitude of the two signals was below 5%. Given the similar amplitude, the signals can be used to determine the time resolution of the detector under test, without the need of an external timing reference.

The APD temperature was  $-20^{\circ}$ C during all measurements reported in this section. For the measurements of intensity as a function of bias voltage and the timing measurements using the laser, the light was shone on the centre of the APDs.

#### 5.2 Results

Current-voltage characteristic The current-voltage (IV) characteristic of the APDs is shown, for different fluences, in figure 3. Before irradiation, below 1600 V, the current assumes a value of less than a few nA. In this region the main contribution to the current is thought to be surface current. Between 1600 and 1800 V, the current increases by 4 orders of magnitude. This is the region where the multiplication dominates the IV characteristic of the non-irradiated sensors. The surface current is not affected by multiplication, therefore the multiplication of bulk current in the non-irradiated sensors can not be seen in the IV curve until the gain is sufficiently high.

The irradiation enhances the bulk generation current of the devices, as can be seen in the region between 0 and 1200 V, where the gain of the sensors does not influence the curves. As the bulk current is amplified, the shape of the irradiated sensors' curves is different from that of the non-irradiated sensor. The change in the magnitude of the current at high voltages is different with respect to the non-irradiated sensor, suggesting that the gain of the detectors is reduced by irradiation, or respectively that a higher bias voltage is required to obtain the same gain as for the non-irradiated sensor.

The current related damage rate ( $\alpha$ ) was estimated at 200 V, where no multiplication is expected. Under the assumption that the depleted volume at this voltage does not change with irradiation, the measured value of  $\alpha$  is of the expected order of magnitude.

The sensor irradiated to  $\Phi_{eq} = 3 \cdot 10^{14} \, \mathrm{cm}^{-2}$  shows a breakdown around 1600 V, therefore no information about its IV characteristic is available at higher bias voltages. This also applies to the amplitude measurements presented below.

**Uniformity of response** The uniformity of response was measured using an infrared laser with pulses of an intensity corresponding to 15 MIPs and an amplification of 10 dB. The laser was focused on different parts of the sensors and the average of 256 waveforms was stored and the

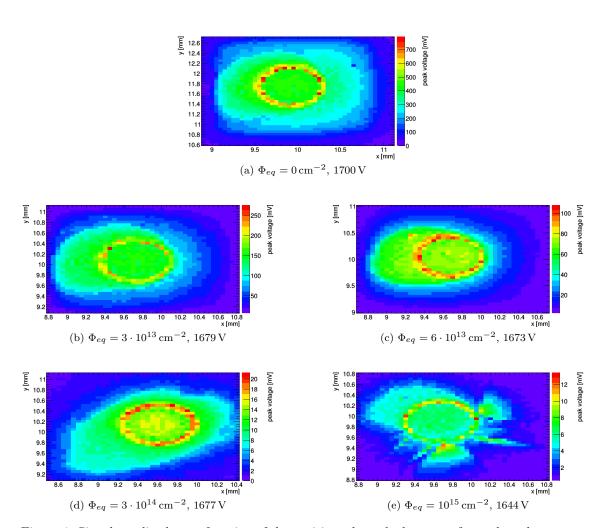


Figure 4: Signal amplitude as a function of the position where the laser was focused on the sensors measured at  $-20^{\circ}$ C. The laser intensity corresponds to 15 MIPs. An amplification of 10 dB was used.

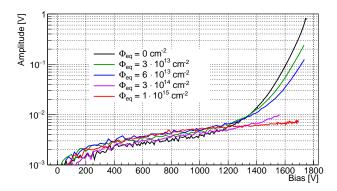


Figure 5: Amplitude of the APDs signal as a function of bias voltage and fluence measured at  $-20^{\circ}$ C. The laser intensity corresponds to 15 MIPs. An amplification of 10 dB was used.

signal amplitude extracted. The signal amplitude as a function of position of the laser spot on the sensors is shown in figure 4. The difference in the bias voltage applied to the detectors is due to the current drawn by the detectors under bias. The biasing and readout circuit had a total resistance of  $13\,\mathrm{M}\Omega$  connected in series to the sensor under test. The bias voltage applied to the readout circuit was  $1700\,\mathrm{V}$  for all samples, the difference in voltage from this value are due to the potential drop caused by the sensors' dark current flowing through the  $13\,\mathrm{M}\Omega$  load. All the values of bias voltage presented in the following take into account this effect.

The sensor irradiated to  $\Phi_{eq} = 3 \cdot 10^{14} \,\mathrm{cm}^{-2}$  could be biased at a higher voltage with respect to the IV measurement. This is probably a consequence of the annealing of the radiation damage of the detector, due to handling and measurements performed at room temperature, since the measurement shown in figure 4 were performed after the current-voltage and amplitude measurements. This suggests that the annealing status of the detectors can influence their breakdown behaviour.

The amplitude is higher at lower x values, regardless of the fluence. This effect, although not fully understood for these devices, is thought to be similar in origin to the one studied in section 6 for APDs with an active area of  $8 \times 8 \text{ mm}^2$ . In each plot of figure 4, a circular region with increased amplitude is present. This region corresponds to the mesa structure in the back of the devices. Part of the light from the laser is reflected from the curved surface of the mesa toward the active area of the detectors, resulting in an increased signal. The sensitive area of the detectors is affected by irradiation. However, the response of the detectors appears uniform close to the detector centre, in the area enclosed by the mesa structure. The measurements shown in the rest of this section were performed by shining the light in the centre of the detectors.

**Signal amplitude** The amplitude was measured from the baseline of the pulse, calculated using the part of the waveform preceding the laser pulse. The results are shown in figure 5 as a function of bias voltage and fluence.

The measured amplitudes present similar values up to 1200 V, for all the fluences. For voltage values above 1200 V, the signal amplitude decreases with increasing fluence, indicating a reduction of the gain for the irradiated detectors. The behaviour of the detectors indicates that for fluences at least up to  $\Phi_{eq} = 6 \cdot 10^{13} \, \mathrm{cm}^{-2}$  the gain of the detectors could be recovered by applying a higher bias voltage.

**Time resolution** The time resolution of the sensors was determined using an infrared laser focused on the detector centre. An optical system was used to have two light pulses shine on the sensor under test for each pulse produced by the laser. A waveform corresponding to one laser pulse is shown in figure 6. The amplification used for the time resolution measurements was 40 dB, and no averaging was applied to the waveforms. 2000 waveforms were acquired for each measurement condition.

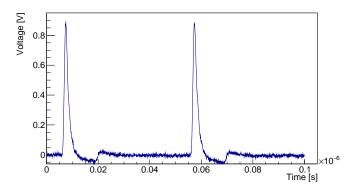


Figure 6: Waveform from a non-irradiated  $2 \times 2 \text{ mm}^2$  APD biased at 1665 V operated at  $-20^{\circ}$ C. The laser intensity corresponds to 0.8 MIPs. An amplification of 40 dB was used.

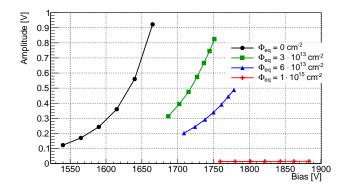


Figure 7: Average amplitude of the  $2 \times 2 \text{ mm}^2$  APDs signal as a function of bias voltage and fluence measured at  $-20^{\circ}\text{C}$ . The laser intensity corresponds to 0.8 MIPs. An amplification of 40 dB was used.

The average signal amplitude as a function of bias voltage and fluence is shown in figure 7. The amplitude is limited by two components of the experimental setup. The limiting factor for the non-irradiated sensor is the amplifier, that has a linear range corresponding to an output amplitude of  $\pm 1\,\mathrm{V}$ . For the irradiated sensors, the maximum current provided by the high voltage power supply was reached, limiting the gain achieved by the devices. The difference between the amplitude of the two signal peaks present in each waveform was less than 5% for each measurement. The time resolution of the sensor irradiated to  $\Phi_{eq} = 3 \cdot 10^{14}\,\mathrm{cm}^{-2}$  was not measured due to its breakdown behaviour that poses a risk to the electronics used in these measurements.

The noise is defined as the standard deviation of the distribution of the waveform points around the baseline, for the portion of the waveform preceding the pulse due to laser illumination. The noise of the APDs, as a function of bias voltage and irradiation fluence, is shown in figure 8. The noise of the APDs with  $\Phi_{eq} \leq 6 \cdot 10^{13} \, \mathrm{cm}^{-2}$  shows a stronger dependence on the applied bias voltage than the the detector irradiated to  $\Phi_{eq} = 10^{15} \, \mathrm{cm}^{-2}$ . This suggests that the multiplication mechanism affects the noise of the sensors.

The signal to noise ratio (SNR) is defined as the ratio between amplitude and noise and is shown in figure 9. The SNR is not a monotone function of the applied bias voltage. The sensor irradiated to  $\Phi_{eq} = 10^{15} \, \mathrm{cm}^{-2}$  shows a weaker dependence of SNR on bias voltage than the other sensors. This is attributed to the lower value of gain of this sensor compared to the others.

The average 20%-to-80% rise time of the sensors is shown in figure 10. The crossing time of the 20% and 80% thresholds was determined using a linear interpolation between two points of the waveform. The values for the sensor irradiated to  $\Phi_{eq} = 10^{15} \, \mathrm{cm}^{-2}$  lie between 5.1 and 5.3 ns and

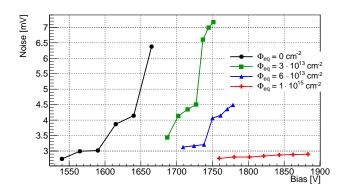


Figure 8:  $2 \times 2$  mm<sup>2</sup> APDs' noise as a function of bias voltage and fluence measured at  $-20^{\circ}$ C. An amplification of 40 dB was used.

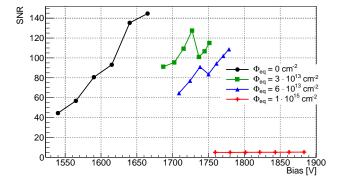


Figure 9: Signal to noise ratio of the  $2\times 2$  mm<sup>2</sup> APDs as a function of bias voltage and fluence measured at  $-20^{\circ}\mathrm{C}$ . The laser intensity corresponds to  $0.8\,\mathrm{MIPs}$ . An amplification of  $40\,\mathrm{dB}$  was used.

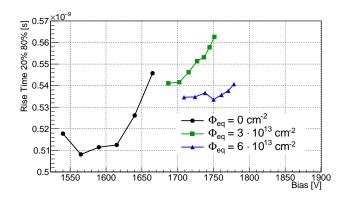


Figure 10: 20%-to-80% rise time of the  $2 \times 2$  mm<sup>2</sup> APDs signal as a function of bias voltage and fluence measured at -20°C. The laser intensity corresponds to 0.8 MIPs. An amplification of  $40 \, \mathrm{dB}$  was used.

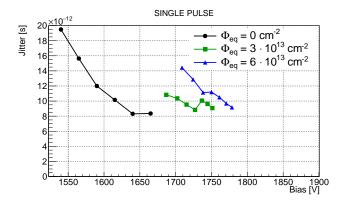


Figure 11: Single pulse time resolution of the  $2 \times 2 \text{ mm}^2$  APDs as a function of bias voltage and fluence measured at  $-20^{\circ}$ C. The laser intensity corresponds to 0.8 MIPs. An amplification of 40 dB was used.

are not shown since they are affected by its low SNR, that does not allow for a correct determination of the 20% point. The rise time increases with increasing bias voltage. The difference between the rise time of the sensors lies within 11%, the rise time does not seem to be affected by irradiation.

The time resolution of the sensors was determined using the two pulses acquired in each waveform. The waveforms are divided in two parts of 50 ns each. The pulses are analysed independently. The time difference between the pulses is calculated using a constant fraction discriminator (CFD) algorithm. This algorithm was chosen since it allows to study the effect of different thresholds applied to the pulses with relative ease, without having to account for the pulse amplitude. The thresholds applied to the pulses were optimised for each measurement condition, choosing the combination that resulted in the best time resolution. The time resolution is defined as the standard deviation of the distribution of the time difference ( $\Delta t$ ) between the pulses. The crossing time of the thresholds was determined using a linear interpolation between two points of the waveform. Since the difference in the amplitude of the pulses measured in the same waveform was less than 5%, the time jitter of the sensor and readout electronics for a single pulse (or single pulse time resolution) can be calculated by dividing the two pulses time resolution by  $\sqrt{2}$ . The single pulse time resolution of the detectors is shown in figure 11 as a function of bias and fluence. The jitter of the sensor irradiated to  $\Phi_{eq} = 10^{15} \, \mathrm{cm}^{-2}$  lies between 508 and 553 ps. These values are not shown in the figure for clarity. The other sensors show a trend of decreasing jitter as a function of bias voltage. The behaviour is however not monotonous.

The jitter is found to scale approximately as 1/SNR. Figure 12 shows the jitter as a function

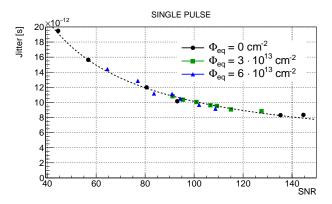


Figure 12: Single pulse time resolution of the  $2 \times 2 \text{ mm}^2$  APDs as a function of signal to noise ratio and fluence measured at  $-20^{\circ}$ C. The laser intensity corresponds to 0.8 MIPs. An amplification of 40 dB was used.

of SNR. The dashed line represents a 1/SNR behaviour.

The jitter of the sensors is not degraded by the neutron-induced radiation damage corresponding to a fluence of at least  $\Phi_{eq} = 6 \cdot 10^{13} \, \mathrm{cm}^{-2}$ . This result is expected to hold for timing measurements of charged particles. The overall resolution is however expected to worsen due to the fluctuations of the amount of charge deposited per unit length along the particle path. These fluctuations, also known as *Landau noise* [12], can influence the leading edge of the sensor's signal and therefore worsen the time resolution.

# 6 Uniformity Study of $8 \times 8$ mm<sup>2</sup> APDs using an Infrared Laser

The uniformity of response of the  $8 \times 8 \text{ mm}^2$  APDs was studied using an infrared laser. The amplitude and integrated signal are shown in figure 13 as a function of the position were the laser illuminated the detector. The sensor was mounted with the n-side facing the PCB, and the laser shone on the p-side. The sensor was contacted using opaque conductive paint. The point of contact on the p-side can be seen at the coordinate (4.5, 6) mm. Since the absorption length of the light used in the measurements is greater than the sensor thickness, several features of the surface below the sensor can be seen in the figure. The square mesa structure and the conductive paint used to glue the detector to the PCB used for the measurements can be seen as areas of increased amplitude and signal integral due to their reflection of the light toward the sensor. The PCB has a hole below the detector centre, that results in decreased values of amplitude and signal integral. Since the signal amplitude is affected by both the deposited charge in the detector and the detector properties, the amplitude was normalised using the integrated signal in order to mitigate the former effect. The ratio between the amplitude and the integrated signal is shown in figure 13. The effects of the surface below the sensor are reduced and a dependency of the ratio between amplitude and charge on the distance between the laser spot and the point where the signal is collected from the sensor can be seen. The amplitude of the signal decreases with increasing distance from the electrical contact. This effect is attributed to the non-negligible resistivity of the conductive layers applied to the detector. The dependency of the signal amplitude on the detector position can result in a worsened time resolution.

The two approaches taken to reduce this source of non-uniformity are described in section 3. The DC-coupled metallisation resulted in a difference in the ratio between amplitude and charge of less than 2% over a distance of 7 mm between the points illuminated by the laser. No dependency on the distance between illumination and electrical contact was observed. This measurement was performed on a sensor biased to  $1800\,\mathrm{V}$  at a temperature of  $20^{\circ}\mathrm{C}$ . The metallisation was performed

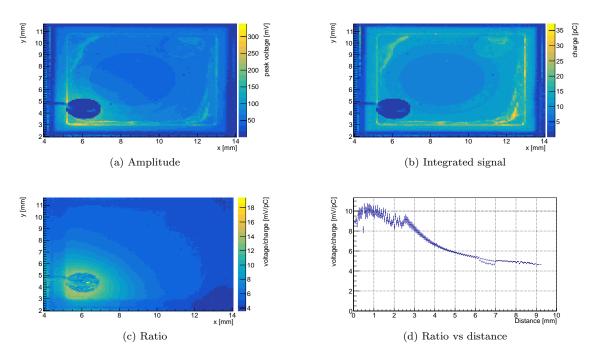


Figure 13: Signal amplitude (a), integral (b), and ratio between amplitude and integral (c) of a  $8 \times 8 \text{ mm}^2$  APD as a function of position. (d) Ratio between amplitude and integral as a function of distance from the electrical contact of the sensor. The sensor was biased at 1700 V, at a temperature of  $-20^{\circ}$ C. The laser intensity corresponds to 15 MIPs. An amplification of 10 dB was used.

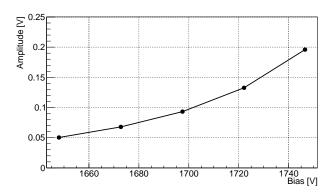


Figure 14: Average amplitude of the metallised  $8\times8~\text{mm}^2$  APD signal as a function of bias voltage measured at 20°C. The laser intensity corresponds to 0.8 MIPs. An amplification of 40 dB was used.

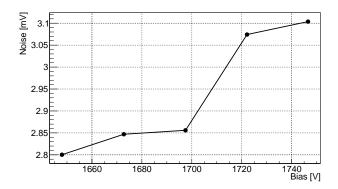


Figure 15:  $8 \times 8 \text{ mm}^2$  APD's noise as a function of bias voltage measured at 20°C. An amplification of 40 dB was used.

at the clean room facility of CMi-EPFL [13]. The structure consists of an aluminium grid on the n-side and a continuous aluminium layer with an opening at the detector centre on the p-side of the detector. This configuration allows the illumination of the detector centre without reflections.

# 7 Timing Performance of $8 \times 8$ mm<sup>2</sup> APDs using an Infrared Laser

The time resolution of the metallised  $8\times 8~\text{mm}^2$  APDs with DC-coupled readout was studied using the same setup and procedure used for the characterisation of the irradiated  $2\times 2~\text{mm}^2$  APDs in section 5. A light intensity corresponding to 0.8~MIPs and an amplification of 40~dB were used. The light was shone in the centre of the detector. The signal amplitude and noise are shown in figure 14 and 15, respectively. The signal amplitude is smaller than the one of the  $2\times 2~\text{mm}^2$  devices shown in section 5. This can be a consequence of a lower gain of the device under test or the bigger capacitance of the device. The noise is also smaller than the one of the  $2\times 2~\text{mm}^2$  devices. Both signal amplitude and noise increase as a function of bias voltage. The signal to noise ratio is lower than the one of the non-irradiated  $2\times 2~\text{mm}^2$  APD presented in section 5, ranging from 18 to 62.

The 20%-to-80% rise time of the signal is shown in figure 16. The values are bigger than the ones of the  $2 \times 2 \text{ mm}^2$  devices. This is a consequence of the bigger sensor capacitance.

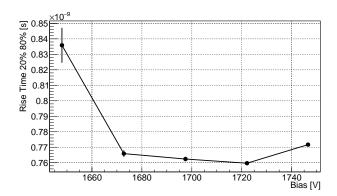


Figure 16: 20%-to-80% rise time of the metallised  $8 \times 8 \text{ mm}^2$  APD signal as a function of bias voltage measured at 20°C. The laser intensity corresponds to 0.8 MIPs. An amplification of 40 dB was used.

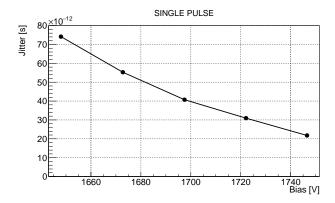


Figure 17: Single pulse time resolution of the metallised  $8 \times 8 \text{ mm}^2$  APDs as a function of bias voltage measured at  $20^{\circ}$ C. The laser intensity corresponds to 0.8 MIPs. An amplification of 40 dB was used.

The jitter was calculated with the same procedure presented in section 5. The jitter decreases with increasing bias voltage and is found to scale with a 1/SNR behaviour.

The metallised  $8 \times 8 \text{ mm}^2$  APDs often did not allow for a stable operation when biased above 1700 V. The source of the instability is under investigation. This instability influenced the choice of values of bias voltage used in this section.

## 8 Beam Tests of 8×8 mm<sup>2</sup> APDs with AC-coupled Readout

Several mesh readout  $8 \times 8$  mm<sup>2</sup> APDs were characterized in terms of their uniformity of response using a 150 GeV muon beam in the H4 beam line at the CERN SPSref?. For the measurements described below a fast transimpedence amplifier with roughly 10 ohm effective input impedance was used(ref. suggestion from Mitch). The bandwidth of the amplifier was 1 GHz. The measurements were carried out within the infrastructure of PICOSEC [14]. In particular, the PICOSEC setup provided particle tracking with a resolution of 40  $\mu$ m and a time reference based on a Hamamatsu MCP PMT<sup>2</sup> which detected charged particles by the Cerenkov light produced in the quartz entrance window providing a reference time jitter of < 10 picoseconds [15]. reference frame of the beam test? APD temperature? Selection cuts?

<sup>&</sup>lt;sup>2</sup>Micro Channel Plate Photomultiplier.

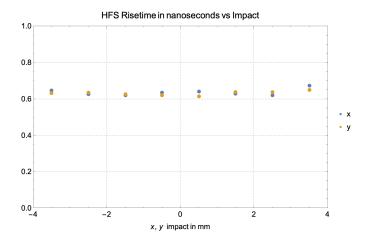


Figure 18: Mean 20-to-80% rise time as a function of impact position for a mesh readout APD. The measurement was performed using 150 GeV muons. The APD was operated at 1750 V, at a temperature of ...°C.

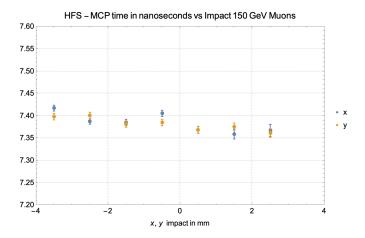


Figure 19: Average time of arrival as a function of impact position for a mesh readout APD. The measurement was performed using 150 GeV muons. The MCP PMT defines the origin of the time axis. The APD was operated at 1750 V, at a temperature of ... °C.

Using the above setup and a 2.5 GHz 20 GSa/s digital oscilloscope to record the waveforms the timing measurements of the mesh readout APDs were derived using a 20% constant fraction algorithm (to define the signal time of arrival). To ensure the consistency of this timing measurement the dependence of waveform characteristics (particularly the rise time) on impact position of muons was studied using the H4 beam data. For this particular study a sample of  $\approx 1000$  events were recorded with the sensor operated at a bias of 1750 V resulting in a most probable amplitude (MIP peak) of 65 mV at the oscilloscope input. The typical pulse rise time (measured at 20-80% levels) was 630 picoseconds with an RMS spread of  $\approx 160$  picoseconds. Figure 18 shows the average risetime as a function of the impact position of the particles for both the x and y directions. The rise time is essentially independent of the point of impact.

Figure 19 shows the time of arrival of the particles as measured by the mesh readout APD as a function of impact position. The MCP PMT is used to define the origin of the time axis.

The dependence of the signal amplitude on the muons' impact position is shown in figure 20. The figure shows the median amplitude obtained at different positions on the detector. The amplitude shows small variations within the detector active area and falls within  $\approx 200 \ \mu \text{m}$  from

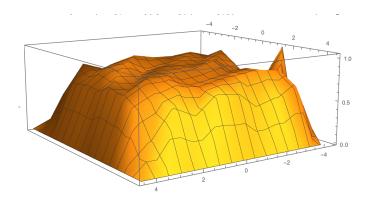


Figure 20: Median amplitude as a function of impact position for a mesh readout APD. The measurement was performed using 150 GeV muons. The APD was operated at 1750 V, at a temperature of ...°C.

the detector edges ( $\approx 4.5$ mm from the center).

## 9 Summary

For their operation at HL-LHC, the ATLAS and CMS experiments foresee timing systems for minimum ionising particles, aiming to a resolution around 30 ps. The detectors used in these systems will be subjected to fluences of up to  $\Phi_{eq} = 10^{15} \, \mathrm{cm}^{-2}$  for the goal integrated luminosity of HL-LHC of 3000 fb<sup>-1</sup>.

The parameters influencing the time resolution of deep diffused APDs with DC-coupled readout, as well as the uniformity of response of these devices, were measured.

Deep diffused APDs with an active area of  $2\times 2\,\mathrm{mm}^2$  produced by RMD were irradiated with reactor neutrons up to a fluence of  $\Phi_{eq}=10^{15}\,\mathrm{cm}^{-2}$ . The uniformity of response was studied using a pulsed infrared laser. The sensitive area of the detectors is affected by irradiation, maintaining an uniform response at the centre of the sensors. Current, amplitude, and timing characteristics of the detectors were measured at a temperature of  $-20^{\circ}\mathrm{C}$ , before and after irradiation. From the current-voltage characteristic it was found that the bulk current of the detectors increases with irradiation and that the gain decreases with irradiation. The latter observation is supported by measurements of the APDs signal performed using a pulsed infrared laser shone at the centre of the detectors. The time jitter of the APDs was determined using a pulsed infrared laser with an intensity corresponding to  $0.8\,\mathrm{MIPs}$  per pulse. The laser was shone at the centre of the detectors. The jitter is not degraded by exposure to fluences of up to at least  $\Phi_{eq}=6\cdot10^{13}\,\mathrm{cm}^{-2}$ . The jitter of the device irradiated to  $\Phi_{eq}=3\cdot10^{14}\,\mathrm{cm}^{-2}$  could not be determined due to its unstable behaviour, while the device irradiated to  $\Phi_{eq}=10^{15}\,\mathrm{cm}^{-2}$  did not show any gain.

The uniformity of response of deep diffused APDs with an active area of  $8\times8\,\mathrm{mm}^2$  was studied using an infrared laser. The amplitude of the signal shows a dependency on the distance between the point where the laser is shone and the electrical contact of the sensor. The deposition of an aluminium layer on the detector surfaces improved the uniformity. The timing characteristics of the metallised  $8\times8\,\mathrm{mm}^2$  APD were studied using a pulsed infrared laser with an intensity corresponding to  $0.8\,\mathrm{MIPs}$  per pulse. The the time jitter was found to be 22 ps at a voltage of 1750 V. The metallised sensors often shown instabilities when biased above 1700 V. The origin of these instabilities is under investigation.

Detectors with both DC- and AC-coupled readout will be characterised in beam tests to complement the information provided in this paper. The determination of time resolution, uniformity of response, and detection efficiency are the aim of the beam tests. The time resolution measurements with charged particles will include the *Landau noise* term. A comparison with the jitter obtained with infrared light will provide a direct measurement of how this effect influences the

time resolution in these devices.

The conclusions for the beam test and gain part have to be written

## Acknowledgments

The work summarised in this paper has been performed within the framework of the RD50 collaboration. This project has received funding from the European Union's Horizon 2020 Research and Innovation programme under Grant Agreement no. 654168. The authors wish to thank J. Bronuzzi for the help during the clean room operations and in the development of the recipe for the metallisation of the devices. The authors are grateful to the members of the CERN EP-DT-DD SSD team that developed and maintain the setups used in this work.

### References

- [1] HiLumi LHC Collaboration, "HiLumi LHC Technical Design Report." http://hilumilhc.web.cern.ch/science/deliverables, 2015.
- [2] CMS Collaboration, "TECHNICAL PROPOSAL FOR A MIP TIMING DETECTOR IN THE CMS EXPERIMENT PHASE 2 UPGRADE," Tech. Rep. CERN-LHCC-2017-027. LHCC-P-009, CERN, Geneva, Dec 2017.
- [3] ATLAS Collaboration, "Technical Proposal: A High-Granularity Timing Detector for the AT-LAS Phase-II Upgrade," Tech. Rep. CERN-LHCC-2018-023. LHCC-P-012, CERN, Geneva, Jun 2018.
- [4] Radiation Monitoring Devices Inc. 44 Hunt St. Watertown USA, http://rmdinc.com/.
- [5] S. White, "R&D for a Dedicated Fast Timing Layer in the CMS Endcap Upgrade," *Acta Physica Polonica B Proceedings Supplement*, vol. 7, no. 4, 2014.
- [6] M. McClish, R. Farrell, F. Olschner, M. R. Squillante, G. Entine, and K. S. Shah, "Characterization of very large silicon avalanche photodiodes," in *IEEE Symposium Conference Record Nuclear Science* 2004., vol. 2, pp. 1270–1273 Vol. 2, Oct 2004.
- [7] R. Farrell and K. Vanderpuye, "Large area semiconductor detector with internal gain," Sept. 11 2007. US Patent 7,268,339.
- [8] R. H. Redus and R. Farrell, "Gain and noise in very high-gain avalanche photodiodes: theory and experiment," *Proc.SPIE*, vol. 2859, pp. 288 297, 1996.
- [9] L. Snoj, G. Žerovnik, and A. Trkov, "Computational analysis of irradiation facilities at the isi triga reactor," *Applied Radiation and Isotopes*, vol. 70, no. 3, pp. 483 488, 2012.
- [10] V. Cindro, "Private communication."
- [11] CIVIDEC Instrumentation GmbH. Schottengasse 3A Wien Austria, http://cividec.at/.
- [12] N. Cartiglia et al., "Tracking in 4 dimensions," Nuclear Instruments and Methods in Physics Research Section A: Accelerators, Spectrometers, Detectors and Associated Equipment, vol. 845, pp. 47 51, 2017. Proceedings of the Vienna Conference on Instrumentation 2016.
- [13] CMi-EPFL. CH-1015 Lausanne, https://cmi.epfl.ch/.
- [14] J. B. et. al., "PICOSEC: Charged particle timing at sub-25 picosecond precision with a Micromegas based detector," NIM, vol. A 903, pp. 317 – 325, 2018.
- [15] L. Sohl, "Spatial time resolution of MCP-PMTs as a t0-reference," NIM, 2018.